Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1217	(@ad<"20000428") and (wafer with (encapsulant or encapsulate or epoxy))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/18 14:06
L2	638	L1 and (cut or saw or sawing or cutting or dice or dicing)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/18 12:28
L3	5	("4149803").URPN.	USPAT	OR	OFF	2005/10/18 13:24
L4	5	("4149803").URPN.	USPAT	OR	OFF	2005/10/18 13:24
L5	9	("3924323").URPN.	USPAT	OR	OFF	2005/10/18 13:26
L6	95	("20020030258" "3024323" "3512051" "3608186" "3693244" "3706129" "3771219" "3924323" "3959874" "3978578" "4027383" "4070689" "4172907" "4259682" "4530152" "4741787" "4813129" "4833568" "4887149" "4956132" "4980555" "5019673" "5053357" "5128746" "5136365" "5138438" "5139969" "5143865" "5157480" "5219796" "5229916" "5258577" "5266528" "5272114" "5288943" "5302849" "5307561" "5309021" "5334875" "5337216" "5340640" "5356838" "5362656" "5363277" "5373190" "5381032" "5394303" "5408320" "5424250" "5428190" "5444301" "5448511" "5455455" "5580228" "5517057" "5517754" "5558828" "5567656" "5568633" "5641997" "5646446" "5656863" "5665655" "5668404" "5683942" "5698465" "5720843" "5766972" "5776797" "5790380" "5805422" "5874782" "5897337" "5925934" "5930603" "5969426" "6020217" "6043564" "6069408" "6073829" "6083811" "6204074" "6211572" "6294830" "6307261" "6365500").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/18 13:30

L7	15	("3212160" "4600600" "4899107" "5019535" "5071787" "5143865" "5207585" "5225023" "5289346" "5341564" "5348607" "5496775" "5567656" "5663106").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/18 13:34
L8	22	("5824569").URPN.	USPAT	OR	OFF	2005/10/18 13:48
L9	1	("6562663").PN.	USPAT; USOCR	OR	OFF	2005/10/18 13:49
L10	19	("5289346" "5496775" "5547730" "5682066" "5760337" "5804881" "5821456" "5824569" "5844315" "5844319" "5895229" "5930598" "6034333" "6046910" "6214643" "6214650" "6228688" "6372544" "6391762").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/18 13:49
L11	9	("3924323").URPN.	USPAT	OR	OFF	2005/10/18 13:54
L12	20	("3706129").URPN.	USPAT	OR	OFF	2005/10/18 13:56
L13	1	("6562663").PN.	USPAT; USOCR	OR	OFF	2005/10/18 13:56
L14	807	(@ad<"20000428") and ((wafer or chip or die) with ((encapsulant or encapsulate or epoxy or polymer or plastic) and (grind or grinding or cmp or polish)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/18 14:07
L15	731	L14 not L2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/18 14:07